

Features

Unregulated Converters

- Micro Size SIP4 Package
- 3kVDC Isolation
- Industry Standard Pinout
- UL94V-O Package Material
- Custom Solutions Available
- Cost Effective
- Efficiency to 85%

ECONOLINE

DC/DC-Converter

ROM Series

Selection Guide

Part Number	Input Voltage (VDC)	Output Voltage (VDC)	Output Current (mA)	Efficiency (%)
SIP4 Micro Size Pack.				
ROM-xx1.8S	1.8, 3.3, 5, 9, 12, 15, 24	1.8	550	70
ROM-xx3.3S	1.8, 3.3, 5, 9, 12, 15, 24	3.3	303	75
ROM-xx05S	1.8, 3.3, 5, 9, 12, 15, 24	5	200	70-78
ROM-xx09S	1.8, 3.3, 5, 9, 12, 15, 24	9	111	70-78
ROM-xx12S	1.8, 3.3, 5, 9, 12, 15, 24	12	83	78-82
ROM-xx15S	1.8, 3.3, 5, 9, 12, 15, 24	15	66	80-84
ROM-xx24S	1.8, 3.3, 5, 9, 12, 15, 24	24	41	74-85

xx = Input Voltage

Description

The ROM Micro Size DC/DC-Converter has been designed for isolating resp. converting DC Power Rails. It provides a small micro-size package, high efficiency, low output ripple, high 3kVDC Isolation and an extended -40°C to $+85^{\circ}\text{C}$ operating temperature range. State of the art packaging and automated manufacturing ensures cost-effectiveness and short lead times.

Specifications (Core Operating Area)

Input Voltage Range	$\pm 10\%$	
Output Voltage Accuracy	$\pm 5\%$	
Line Voltage Regulation	1.2%/1% of Vin max.	
Load Voltage Regulation (10% to 100% full load)	1.8V, 3.3V output types 5V output type 9V, 12V, 15V, 24V output types	20% max. 15% max. 10% max.
Output Ripple and Noise (20MHz limited)	100mVp-p max.	
Operating Frequency	50kHz min. / 100kHz typ. / 105kHz max.	
Efficiency at Full Load	70% min. / 80% typ.	
No Load Power Consumption	101mW min. / 126mW typ. / 171mW max.	
Isolation Voltage	(tested for 1 second)	3.000VDC min.
Rated Working Voltage	(long term isolation)	see Application Notes
Isolation Capacitance	20pF min. / 75pF max.	
Isolation Resistance	15 G Ω min.	
Short Circuit Protection	1 Second	
Operating Temperature Range (free air convection)	-40°C to $+85^{\circ}\text{C}$ (see Graph)	
Storage Temperature Range	-55°C to $+125^{\circ}\text{C}$	
Relative Humidity	MSL Level 1	95% RH
Package Weight	1g	
MTBF (+25°C) } Detailed Information see (+85°C) } Application Notes chapter "MTBF"	using MIL-HDBK 217F	977 x 10 ³ hours
	using MIL-HDBK 217F	189 x 10 ³ hours

1 Watt

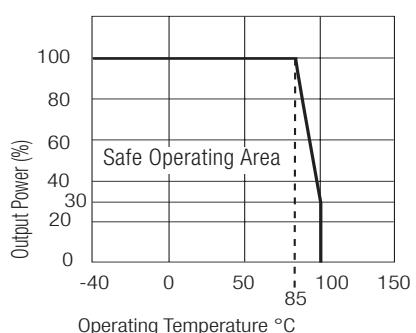
SIP4

Micro Size

Single Output

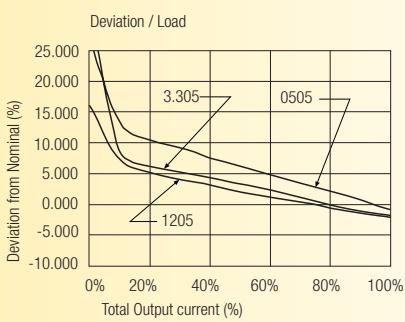
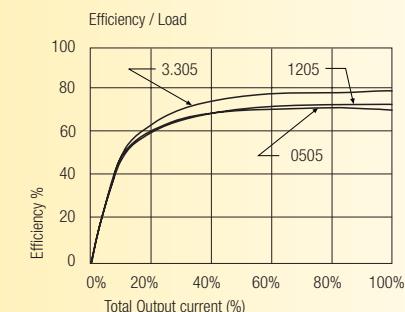


Derating-Graph (Ambient Temperature)

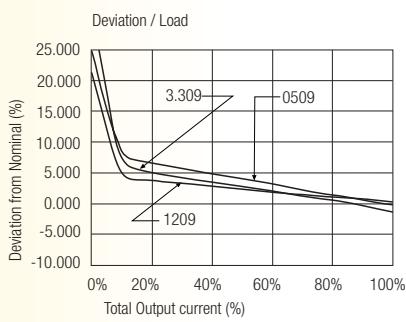
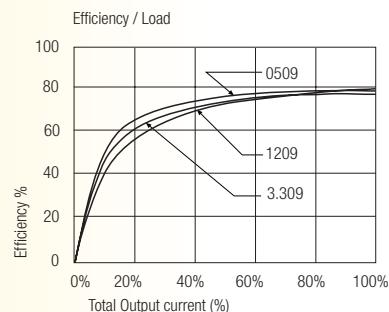


Typical Characteristics

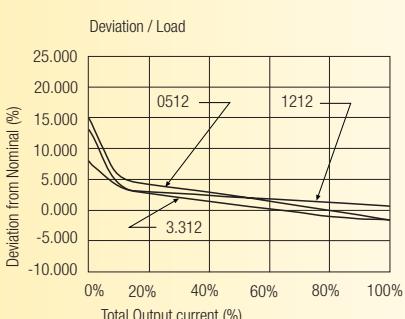
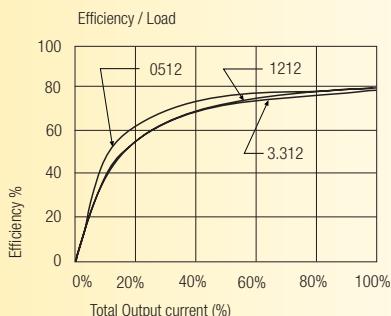
ROM-xx05S



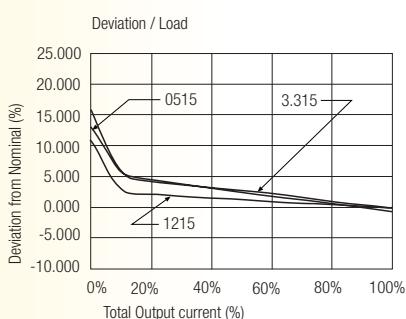
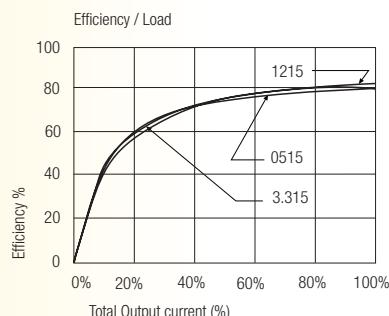
ROM-xx09S



ROM-xx12S



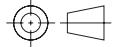
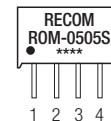
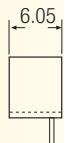
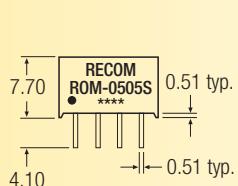
ROM-xx15S



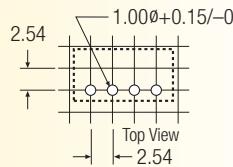
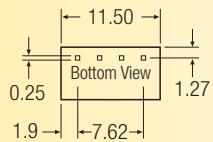
Package Style and Pinning (mm)

4 PIN SIP Micro Size Package

3rd angle projection

Recommended Footprint Details



RO Pin Connections

Pin #	Single
1	-Vin
2	+Vin
3	-Vout
4	+Vout
XX.X	± 0.5 mm
XX.XX	± 0.25 mm